# INTEGRATED CIRCUITS



Product specification Supersedes data of 1995 Nov 14 IC23 Data Handbook 1998 Feb 19





74LVT125

#### **FEATURES**

- Quad bus interface
- 3-State buffers
- Output capability: +64mA/-32mA
- TTL input and output switching levels
- Input and output interface capability to systems at 5V supply
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion/extraction permitted
- No bus current loading when output is tied to 5V bus
- Power-up 3-State
- Latch-up protection exceeds 500mA per JEDEC Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 200V per Machine Model

## QUICK REFERENCE DATA

### DESCRIPTION

The LVT125 is a high-performance BiCMOS product designed for  $V_{CC}$  operation at 3.3V.

This device combines low static and dynamic power dissipation with high speed and high output drive.

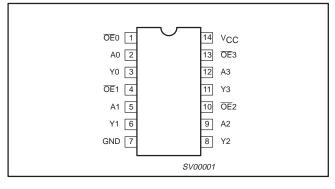
The 74LVT125 device is a quad buffer that is ideal for driving bus lines. The device features four Output Enables ( $\overline{OE0}$ ,  $\overline{OE1}$ ,  $\overline{OE2}$ ,  $\overline{OE3}$ ), each controlling one of the 3-State outputs.

SYMBOL	PARAMETER	CONDITIONS T <sub>amb</sub> = 25°C; GND = 0V	TYPICAL	UNIT
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An to Yn	$C_{L} = 50 pF; V_{CC} = 3.3 V$	2.7 2.9	ns
C <sub>IN</sub>	Input capacitance	V <sub>1</sub> = 0V or 3.0V	4	pF
C <sub>OUT</sub>	Output capacitance	Outputs disabled; $V_0 = 0V \text{ or } 3.0V$	8	pF
I <sub>CCZ</sub>	Total supply current	Outputs disabled; V <sub>CC</sub> = 3.6V	0.13	mA

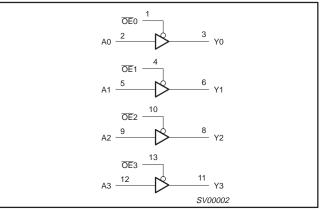
#### **ORDERING INFORMATION**

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
14-Pin Plastic SO	-40°C to +85°C	74LVT125 D	74LVT125 D	SOT108-1
14-Pin Plastic SSOP	-40°C to +85°C	74LVT125 DB	74LVT125 DB	SOT337-1
14-Pin Plastic TSSOP	-40°C to +85°C	74LVT125 PW	74LVT125PW DH	SOT402-1

### **PIN CONFIGURATION**

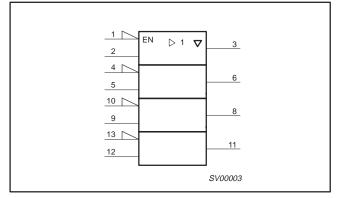


## LOGIC SYMBOL



## 74LVT125

## LOGIC SYMBOL (IEEE/IEC)



## **FUNCTION TABLE (EACH BUFFER)**

INP	INPUTS	
OEn	An	Yn
L	L	L
L	Н	Н
Н	Х	Z

H = High voltage level

L = Low voltage level

X = Don't careZ = High impedance "Off" state

## **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	NAME AND FUNCTION
2, 5, 9, 12	A0 – A3	Data inputs
3, 6, 8, 11	Y0 – Y3	Data outputs
1, 4, 10, 13	OE0 – OE3	Output enables
7	GND	Ground (0V)
14	V <sub>CC</sub>	Positive supply voltage

### **ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>**

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +4.6	V
VI	DC input voltage <sup>3</sup>		-0.5 to +7.0	V
V <sub>OUT</sub>	DC output voltage <sup>3</sup>	Output in Off or High state	-0.5 to +7.0	V
		Output in Low state	128	mA
lout	DC output current	Out in High State	-64	mA
I <sub>IK</sub>	DC input diode current	V <sub>1</sub> < 0	-50	mA
I <sub>ОК</sub>	DC output diode current	V <sub>O</sub> < 0	-50	mA
T <sub>stg</sub>	Storage temperature range		-65 to 150	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

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Product specification

## **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	SYMBOL PARAMETER	LIM	LIMITS		
STMDOL		MIN	UNIT		
V <sub>CC</sub>	DC supply voltage	2.7	3.6	V	
VI	Input voltage	0	5.5	V	
V <sub>IH</sub>	High-level input voltage	2.0		V	
V <sub>IL</sub>	Low-level input voltage		0.8	V	
I <sub>OH</sub>	High-level output current		-32	mA	
IOL	Low-level output current		32	mA	
IOL	Low-level output current; current duty cycle $\leq$ 50%, f $\geq$ 1kHz		64		
$\Delta t/\Delta v$	Input transition rise or fall rate; outputs enabled		10	ns/V	
T <sub>amb</sub>	Operating free-air temperature range	-40	+85	°C	

### **DC ELECTRICAL CHARACTERISTICS**

					LIMITS		
SYMBOL	PARAMETER	TEST CONDITIONS		Temp = -40°C to +85°C			UNIT
					TYP <sup>1</sup>	MAX	
VIK	Input clamp voltage	$V_{CC} = 2.7 V; I_{IK} = -18 mA$			-0.9	-1.2	V
		$V_{CC} = 2.7$ to 3.6V; $I_{OH} = -100\mu A$		V <sub>CC</sub> -0.2	V <sub>CC</sub> -0.1		
V <sub>OH</sub>	High-level output voltage	V <sub>CC</sub> = 2.7V; I <sub>OH</sub> = -8mA		2.4	2.5		V
		V <sub>CC</sub> = 3.0V; I <sub>OH</sub> = -32mA		2.0	2.2		1
		V <sub>CC</sub> = 2.7V; I <sub>OL</sub> = 100μA			0.1	0.2	
		V <sub>CC</sub> = 2.7V; I <sub>OL</sub> = 24mA			0.3	0.5	1
V <sub>OL</sub>	Low-level output voltage	V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 16mA			0.25	0.4	V
		V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 32mA			0.3	0.5	1
		V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 64mA			0.4	0.55	1
		V <sub>CC</sub> = 0 or 3.6V; V <sub>I</sub> = 5.5V	All inputs		1	10	
L.	Input leakage current	$V_{CC} = 3.6V; V_I = V_{CC} \text{ or } GND$	Control pins		±0.1	±1	μA
łį	input leakage current	$V_{CC} = 3.6V; V_{I} = V_{CC}$	Data pins4		0.1	1	μΑ
		$V_{CC} = 3.6V; V_{I} = 0$	Data pins		-1	-5	1
I <sub>OFF</sub>	Output off current	$V_{CC} = 0V$ ; $V_{I}$ or $V_{O} = 0$ to 4.5V			1	±100	μA
		$V_{CC} = 3V; V_{I} = 0.8V$		75	150		
I <sub>HOLD</sub>	Bus Hold current A inputs <sup>6</sup>	$V_{CC} = 3V; V_{I} = 2.0V$		-75	-150		μA
		$V_{CC} = 0V$ to 3.6V; $V_{CC} = 3.6V$		±500			
$I_{EX}$	Current into an output in the High state when $V_O > V_{CC}$	$V_{O} = 5.5V; V_{CC} = 3.0V$			60	125	μΑ
I <sub>PU/PD</sub>	Power up/down 3-State output current <sup>3</sup>	$V_{CC} \le 1.2V$ ; $V_O = 0.5V$ to $V_{CC}$ ; $V_I = GND$ or $V_{CC}$ ; OE/OE = Don't care			±1	±100	μΑ
I <sub>OZH</sub>	3-State output high current	V <sub>CC</sub> = 3.6V; V <sub>O</sub> = 3.0V			1	5	μA
I <sub>OZL</sub>	3-State output low current	$V_{CC} = 3.6V; V_{O} = 0.5V$			-1	-5	μΑ
ICCH		$V_{CC} = 3.6V$ ; Outputs High, $V_I = GND$ or	V <sub>CC</sub> , I <sub>O =</sub> 0		0.13	0.19	
I <sub>CCL</sub>	Quiescent supply current	$V_{CC}$ = 3.6V; Outputs Low, $V_{I}$ = GND or V	$V_{CC}$ , $I_{O} = 0$		2	7	mA
I <sub>CCZ</sub>	1	$V_{CC} = 3.6V$ ; Outputs Disabled; $V_I = GND \text{ or } V_{CC} I_O = 0^5$			0.13	0.19	1
$\Delta I_{CC}$	Additional supply current per input pin <sup>2</sup>	$V_{CC}$ = 3V to 3.6V; One input at $V_{CC}$ -0.6 Other inputs at $V_{CC}$ or GND	V,		0.1	0.2	mA

### NOTES:

All typical values are at V<sub>CC</sub> = 3.3V and T<sub>amb</sub> = 25°C.
This is the increase in supply current for each input at the specified voltage level other than V<sub>CC</sub> or GND
This parameter is valid for any V<sub>CC</sub> between 0V and 1.2V with a transition time of up to 10msec. From V<sub>CC</sub> = 1.2V to V<sub>CC</sub> = 3.3V ± 0.3V a transition time of 100µsec is permitted. This parameter is valid for T<sub>amb</sub> = 25°C only.
Unused pins at V<sub>CC</sub> or GND.

I<sub>CCZ</sub> is measured with outputs pulled to V<sub>CC</sub> or GND.
This is the bus hold overdrive current required to force the input to the opposite logic state.

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### **AC CHARACTERISTICS**

GND = 0V;  $t_R = t_F = 2.5 \text{ns}$ ;  $C_L = 50 \text{pF}$ ;  $R_L = 500 \Omega$ ,  $T_{amb} = -40^{\circ}\text{C}$  to +85°C.

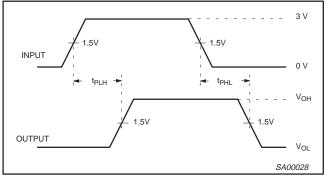
				L	IMITS		
SYMBOL	PARAMETER	WAVEFORM	٧ <sub>c</sub>	<sub>C</sub> = 3.3V ±0.3	3V	V <sub>CC</sub> = 2.7V	UNIT
			MIN	TYP <sup>1</sup>	MAX	MAX	1
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An to Yn	1	1.0 1.0	2.7 2.9	4.0 3.9	4.5 4.9	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Output enable time OEn to Yn	2	1.0 1.1	3.4 3.4	4.7 4.7	6.0 6.5	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output disable time OEn to Yn	2	1.8 1.3	3.7 2.6	5.1 4.5	5.7 4.0	ns

NOTE:

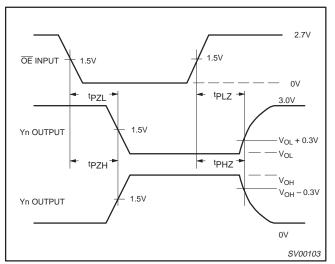
1. All typical values are at V\_{CC} = 3.3V and T\_{amb} = 25^{\circ}C.

## AC WAVEFORMS

 $V_{M} = 1.5V, V_{IN} = GND \text{ to } 2.7V$ 



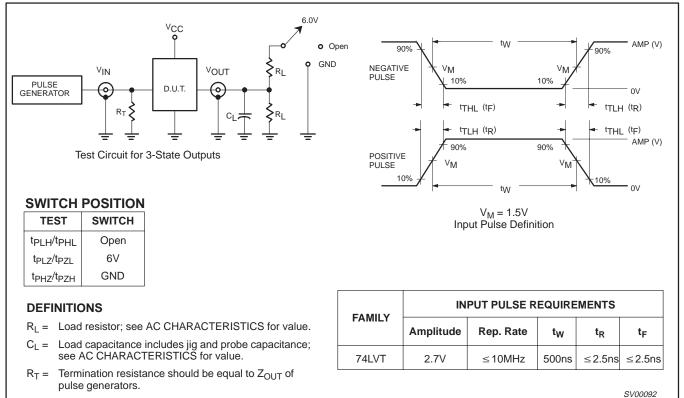
Waveform 1. Input (An) to Output (Yn) Propagation Delays



Waveform 2. 3-State Output Enable and Disable Times

## 74LVT125

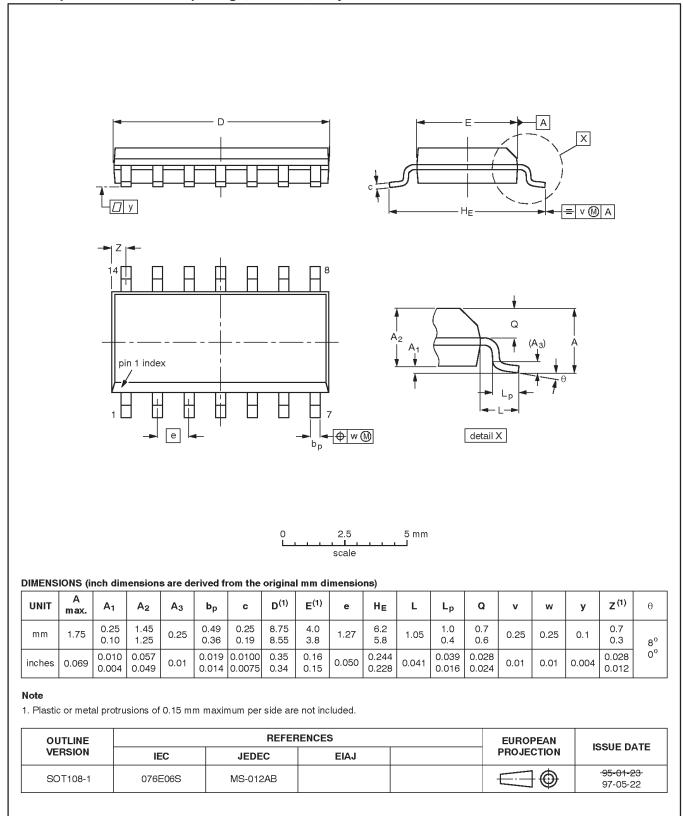
### **TEST CIRCUIT AND WAVEFORMS**



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SOT108-1

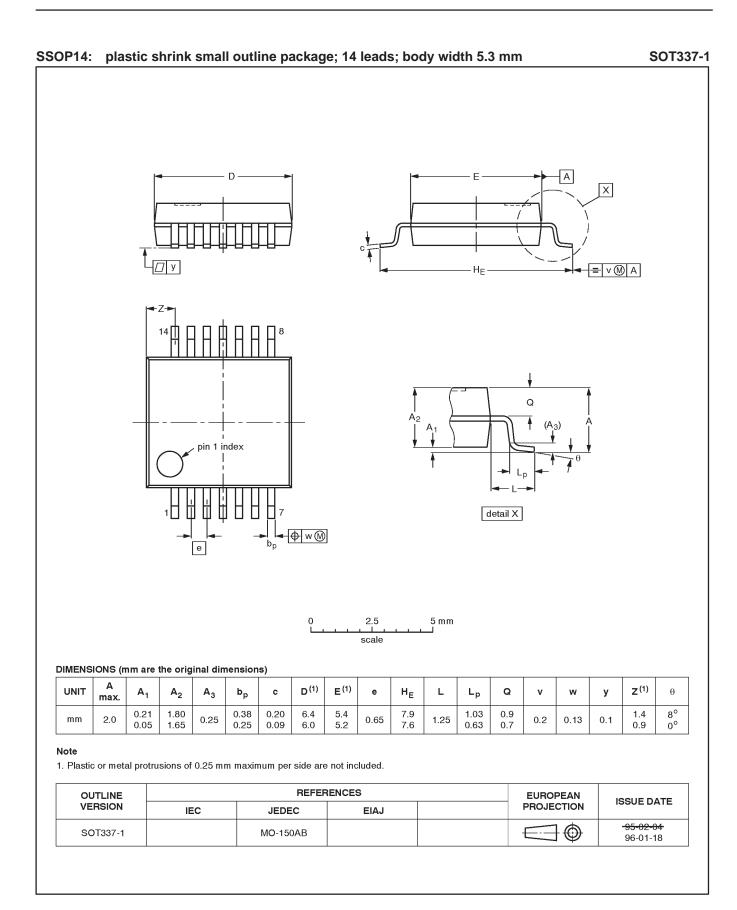
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## SO14: plastic small outline package; 14 leads; body width 3.9 mm

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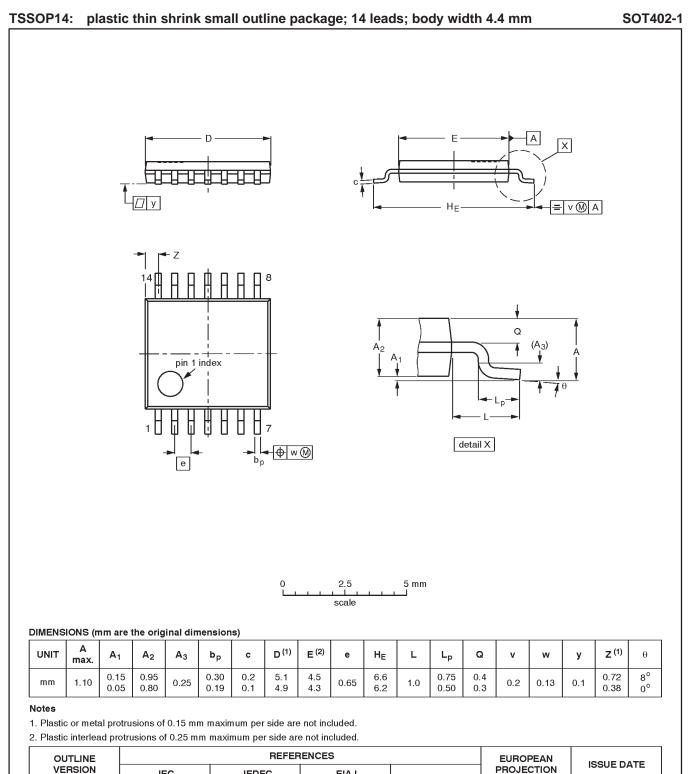
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## 74LVT125

#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

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